



DAGSTUHL
ARTIFACTS SERIES

Volume 10 | Issue 1 | July 2024

Special Issue of the 36th Euromicro Conference on Real-Time
Systems (ECRTS 2024)

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ISSN 2509-8195

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ACM Classification 2012

Software and its engineering

Published online and open access by

Schloss Dagstuhl – Leibniz-Zentrum für Informatik
GmbH, Dagstuhl Publishing, Saarbrücken/Wadern,
Germany.

Online available at

<https://drops.dagstuhl.de/darts>.

Publication date

July 2024

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Digital Object Identifier

10.4230/DARTS.10.1.0

<https://www.dagstuhl.de/darts>

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■ Artifact Evaluation Process

The ECRTS Artifact Evaluation (AE) process takes place after the paper decisions have been finalized. We seek to achieve the benefits of the AE process without disturbing the current process through which ECRTS has generated high-quality programs in the past. Therefore, the current submission, review, and acceptance procedure are completely unaltered by the decision to run an AE process.

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Artifacts should include two components:

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- the software and any accompanying data.

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36th Euromicro Conference on Real-Time Systems (ECRTS 2024).

Editors: Matthias Becker and Catherine E. Nemitz

Dagstuhl Artifacts Series, Vol. 10, Issue 1, Artifact No. 0, pp. 0:ix-0:x



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Dagstuhl Artifacts Series

Schloss Dagstuhl – Leibniz-Zentrum für Informatik, Dagstuhl Publishing, Germany

